

SEMICONDUCTOR

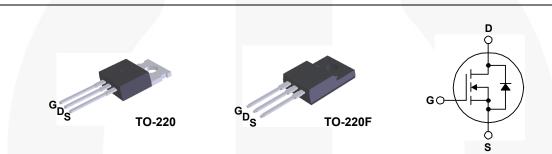
FQP13N50C / FQPF13N50C N-Channel QFET[®] MOSFET 500 V, 13 A, 480 mΩ

Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize onstate resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp bridge topology.

Features

- 13 A, 500 V, $R_{DS(on)}$ = 480 m Ω (Max.) @ V_{GS} = 10 V, I_{D} = 6.5 A
- Low Gate Charge (Typ. 43 nC)
- Low Crss (Typ. 20 pF)
- 100% Avalanche Tested



Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

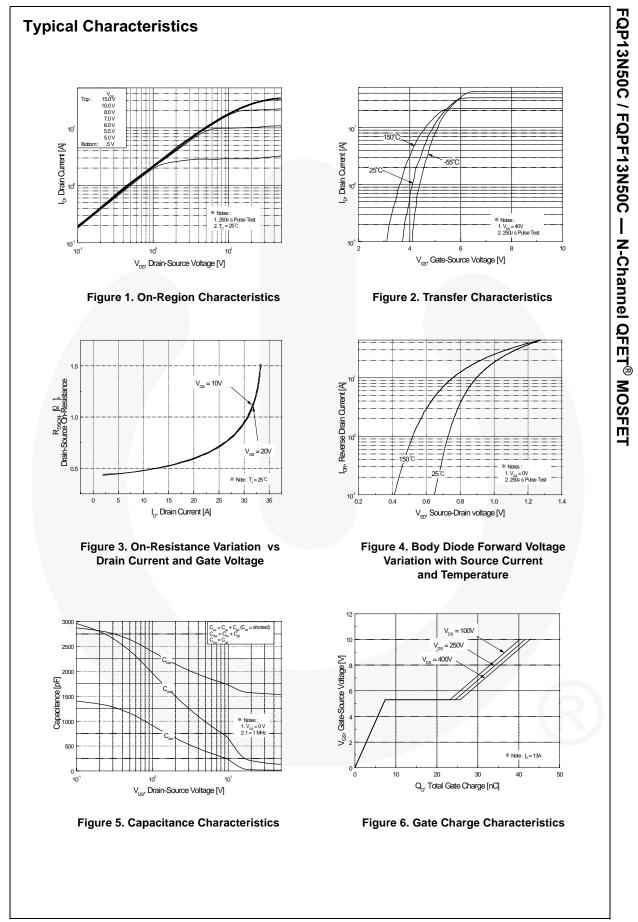
Symbol	Parameter	FQP13N50C	FQPF13N50C	Units	
V _{DSS}	Drain-Source Voltage	5	V		
I _D	Drain Current - Continuous (T _C = 25°	°C)	13	13 *	А
	- Continuous (T _C = 100)°C)	8	8 *	А
I _{DM}	Drain Current - Pulsed	(Note 1)	52	52 *	А
V _{GSS}	Gate-Source Voltage	± 30		V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	860		mJ
I _{AR}	Avalanche Current	(Note 1)	13		А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	19.5		mJ
dv/dt	Peak Diode Recovery dv/dt	4.5		V/ns	
PD	Power Dissipation ($T_C = 25^{\circ}C$)	195	48	W	
	- Derate above 25°C	1.56	0.39	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Ran	-55 to +150		°C	
TL	Maximum lead temperature for soldering	300		°C	
۲L	1/8" from case for 5 seconds				

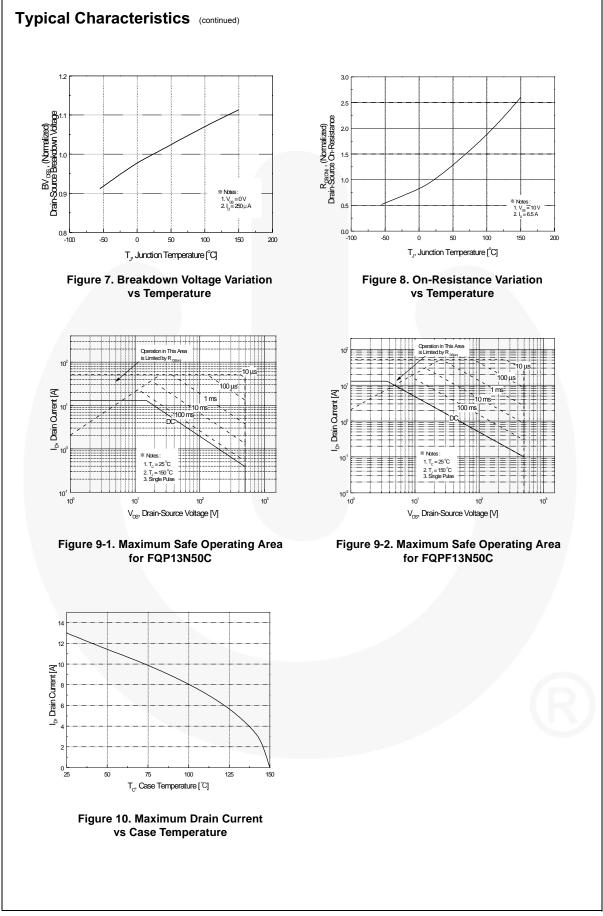
* Drain current limited by maximum junction temperature

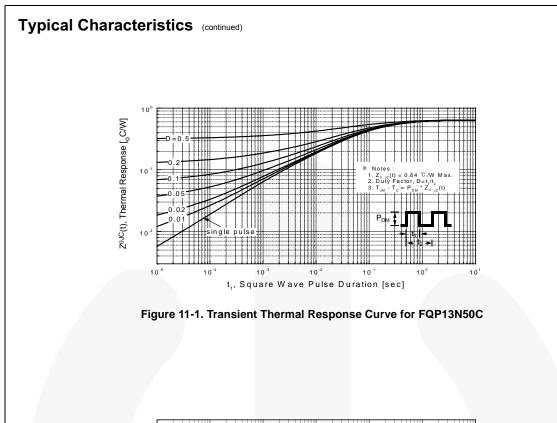
Thermal Characteristics

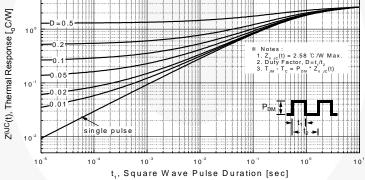
Symbol	Parameter	FQP13N50C	FQPF13N50C	Units	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.64	2.58	°C/W	
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink, Typ.	0.5		°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	62.5	°C/W	

		Top Mark	Package		Packing Method Reel S		Size	Tape Width		Quantity	
		FQP13N50C	TO-2		Tube	N/.	A	N/A		50 units	
		220F Tube N/			A	N/A		50 units			
Electri	cal Cha	racteristics ⊤	_c = 25°C unl	ess otherv	vise noted.						
Symbol		Parameter			Test Conditions		Min	Тур	Max	Unit	
Off Cha	aracteristi	cs									
BV _{DSS}	Drain-Sour	rce Breakdown Volta	age V _{GS} =		0 V, I _D = 250 μA		500			V	
ΔBV _{DSS} / ΔT _J	Breakdowr Coefficient	n Voltage Temperatu	ire	I _D = 25	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$			0.5		V/°C	
I _{DSS}	SS Zero Gate Voltage Drain Current		nt	V_{DS} = 500 V, V_{GS} = 0 V					1	μA	
	Zero Gale	Voltage Drain Curre		V _{DS} = 400 V, T _C = 125°C					10	μA	
I _{GSSF}	-	Leakage Current, F				80 V, V _{DS} = 0 V			100	nA	
I _{GSSR}	Gate-Body	Leakage Current, F	Reverse	V _{GS} =	-30 V, V _{DS} = 0 V				-100	nA	
On Cha	racteristi	cs									
V _{GS(th)}	-	shold Voltage		V _{DS} =	V _{GS} , I _D = 250 μA		2.0		4.0	V	
R _{DS(on)}	Static Drain On-Resista			V _{GS} = 10 V, I _D = 6.5 A			0.39	0.48	Ω		
9 _{FS}	Forward Tr	ransconductance		V _{DS} =	40 V, I _D = 6.5 A			15		S	
	ic Charac										
C _{iss}	Input Capa		V _{DS} =		25 V, V _{GS} = 0 V,			1580	2055	-	
C _{oss}	Output Ca		_	f = 1.0 MHz				180	235	pF	
C _{rss}	Reverse Ti	ransfer Capacitance	•					20	25	pF	
Switchi	ing Chara	cteristics									
t _{d(on)}	Turn-On D			V _{DD} = 250 V, I _D = 13 A,			25	60	ns		
t _r	Turn-On R	ise Time		$R_{\rm G} = 250 {\rm V}, {\rm I_D} = 13 {\rm A},$			100	210	ns		
t _{d(off)}	Turn-Off D	elay Time						130	270	ns	
t _f	Turn-Off Fa	all Time				(Note 4)		100	210	ns	
Qg	Total Gate	Charge		V _{DS} = 400 V, I _D = 13 A, V _{GS} = 10 V				43	56	nC	
Q _{gs}	Gate-Sour	ce Charge						7.5		nC	
Q _{gd}	Gate-Drain	n Charge		(Note 4				18.5		nC	
Drain-S	T	ode Characteris Continuous Drain-Se			•				13	Α	
I _{SM}		Pulsed Drain-Source							52	A	
V _{SD}		ce Diode Forward V			= 0 V, I _S = 13 A			/	1.4	V	
•so t _{rr}		ecovery Time	onuge		$0 \text{ V}, \text{ I}_{\text{S}} = 13 \text{ A},$			410		ns	
Q _{rr}					$t = 100 \text{ A}/\mu \text{s}$			4.5		μC	
~11	ACTOR A	rse Recovery Charge			αι _Γ / αι = 100 Α/μδ			7.0		μΟ	

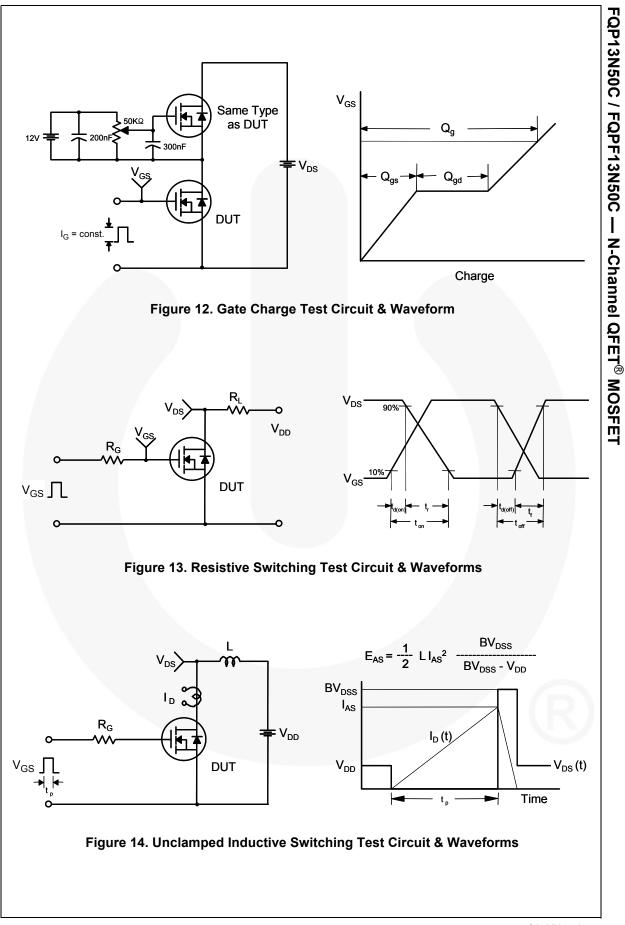


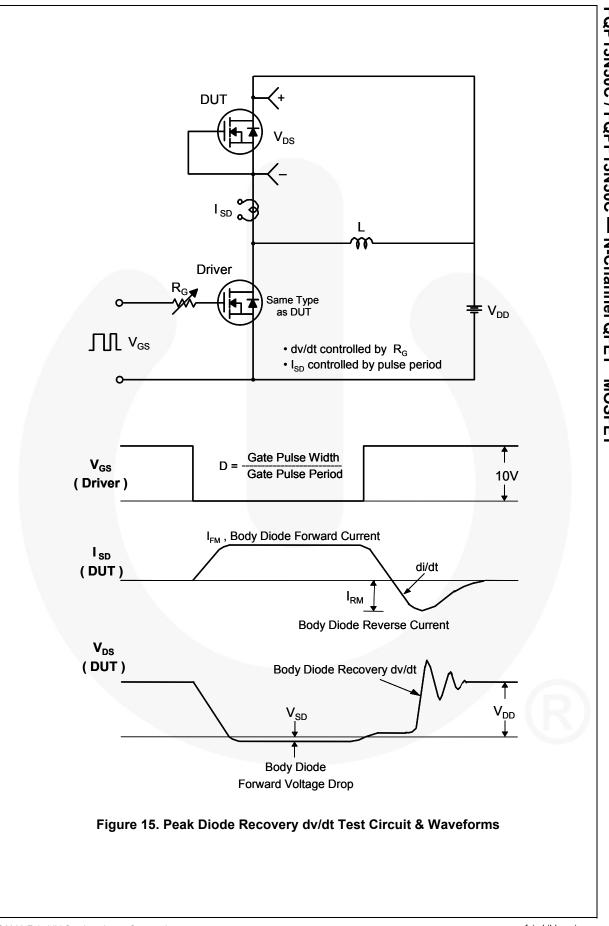


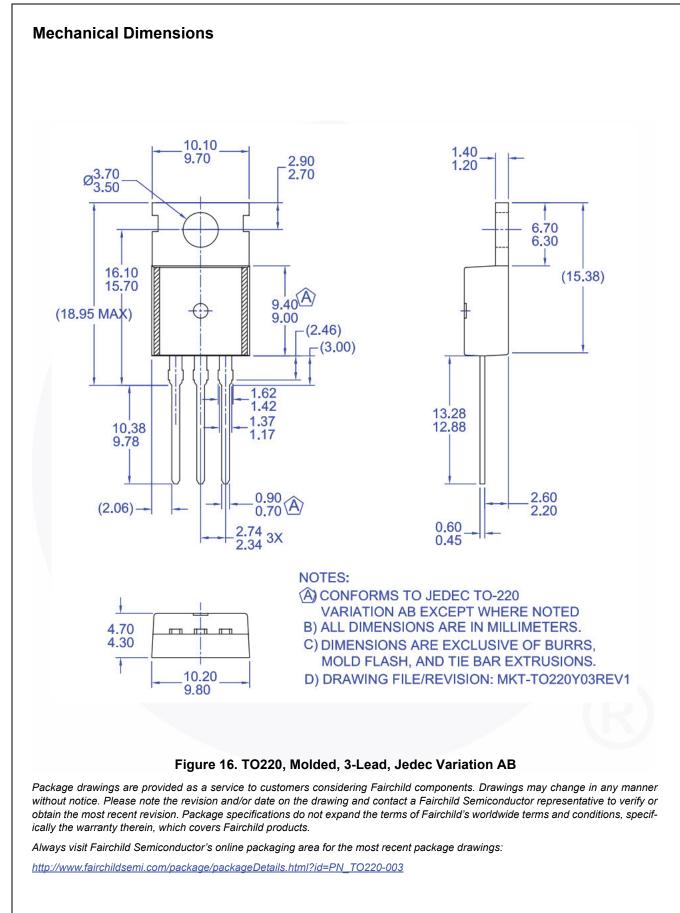


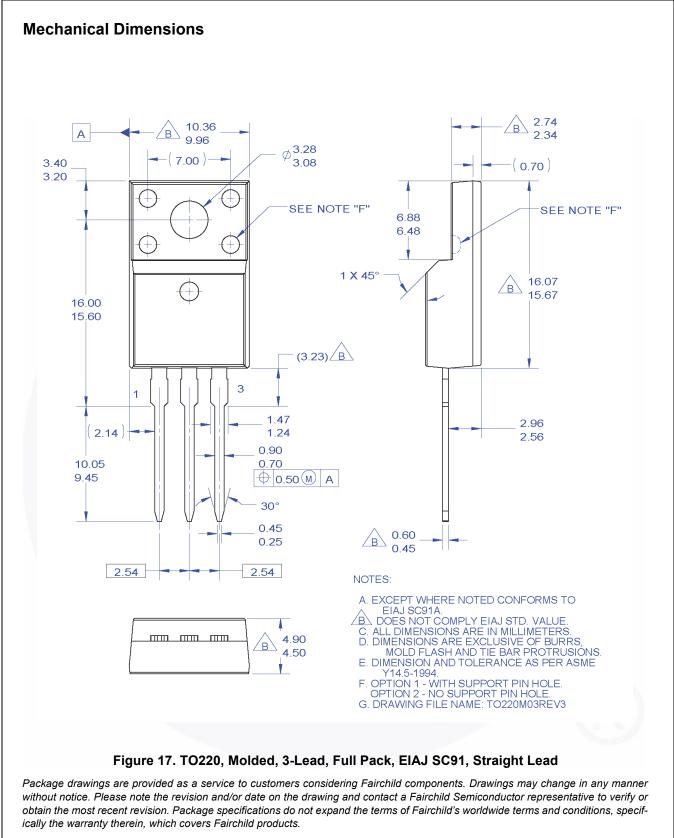












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N-Channel QFET[®] MOSFET



Datasheet Identification Product Status		Definition
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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